PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hsiu-Wen Tu	10/06/2009
Ren-Long Kuo	10/06/2009
Young-Houng Shiao	10/06/2009
Tsao-Pin Chen	10/06/2009
Mon-Nam Ho	10/06/2009
Chih-Cheng Hsu	10/06/2009
Chin-Fu Lin	10/06/2009
Chung-Hsien Hsin	10/06/2009

RECEIVING PARTY DATA

Name:	Kingpak Technology Inc.	
Street Address:	No. 84, Tai-Ho Rd., Chu-Pei 302	
City:	Chu-Pei City, Hsin-Chu Hsien	
State/Country:	TAIWAN	
Postal Code:	302	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12579493

CORRESPONDENCE DATA

Fax Number: (703)739-9557

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703-739-4900

Email: Igreene@stites.com

Correspondent Name: Juan Carlos A. Marquez

Address Line 1: 1199 N. Fairfax Street, Suite 900

Address Line 2: Stites & Harbison PLLC
Address Line 4: Alexandria, VIRGINIA 22314

PATENT

REEL: 023375 FRAME: 0067

P \$40.00 125/9493

500989002

ATTORNEY DOCKET NUMBER:	CHIP.0079
NAME OF SUBMITTER:	Juan Carlos A. Marquez
Total Attachments: 2 source=assignment#page1.tif source=assignment#page2.tif	

PATENT REEL: 023375 FRAME: 0068

ASSIGNMENT

WHEREAS, 1.TU, Hsiu-Wen, 2.KUO, Ren-Long 3.SHIAO, Young-Houng 4. CHEN, Tsao-Pin 5. HO, Mon-Nam 6.HSU, Chih-Cheng 7.LIN, Chin-Fu 8.HSIN, Chung-Hsien whose post office addresses appear below hereinafter referred to as Assignor), have invented certain new and useful improvements in a IMAGE SENSOR PACKAGE STRUCTURE (hereinafter referred to as The Invention) for which an application for United States Letters Patent was filed on, Application Number;				
WHEREAS, Kingpak Technology Inc. whose post office address is No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien, Taiwan, R.O.C. (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;				
NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.				
ALSO, Assignor hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of Assignee in and to said invention, all without further consideration. Assignor also agrees, without further consideration and at Assignee's expense, to identify and communicate to Assignee at Assignee's request documents and information concerning the invention that are within Assignor's possession or control, and to provide further assurances and testimony on behalf of Assignee that lawfully may be required of Assignor in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. Assignor's obligations under this instrument shall extend to Assignor's heirs, executors, administrators and other legal representatives. Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to Assignee of the entire right, title and interest in and to the same, for Assignee's				
sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.				
Name	TU, Hsiu-Wen	Signature Tu, Hsin-Wen		
Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,	•		
	Taiwan, R.O.C.	Date October 06, 2009		
Name	KUO, Ren-Long	Signature Kuo, Ron-Long		
Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,			
	Taiwan, R.O.C.	Date October 06, 2009		
Name	SHIAO, Young-Houng	Signature Micer		

PATENT REEL: 023375 FRAME: 0069

Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,	
	Taiwan, R.O.C.	Date October 06, 2009
Name	CHEN, Tsao-Pin	signature Chen Tsao-pin
Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,	
	Taiwan, R.O.C.	Date October 06, 2009
Name	HO, Mon-Nam	Signature Ho Mon Mau
Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,	
	Taiwan, R.O.C.	Date October 06, 2009
Name	HSU, Chih-Cheng	signature HSU, Chih - Cheng
Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,	1
	Taiwan, R.O.C.	Date October 06, 2009
Name	LIN, Chin-Fu	Signature Lin. Chin-Fy
Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,	
	Taiwan, R.O.C.	Date October 06, 2009
Name	HSIN, Chung-Hsien	Signature DTLL
Address	No. 84, Tai-Ho Rd., Chu-Pei 302, Hsin-Chu Hsien,	
	Taiwan, R.O.C.	Date October 06, 2009

PATENT REEL: 023375 FRAME: 0070